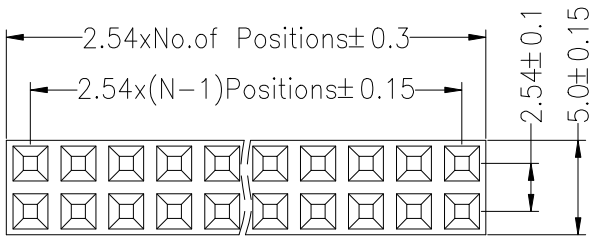
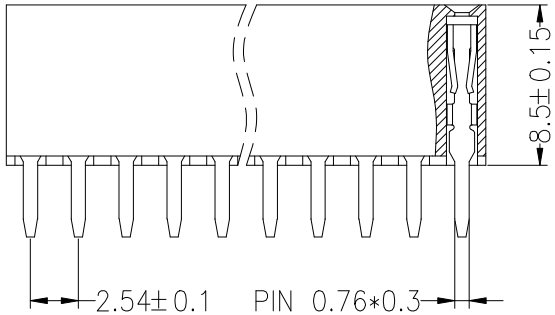
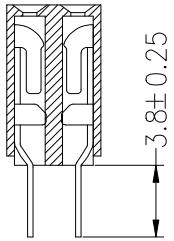
HSF RoHS FILE NO:E382810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



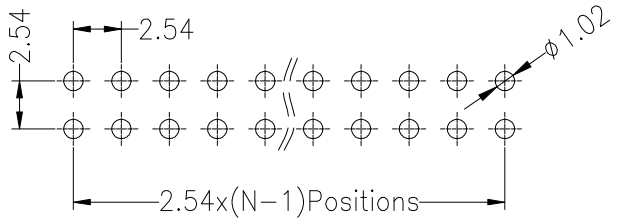




Ordering Information

2285 02 XX X N XX S O X 0X

- 2285 02 XX: No.of Pins Per Row 2~40
- X: Insulator Material Option
  - A=BK−PBT
  - C=BK−PA6T
  - E=BK−PA9T
  - F=BK−LCP
- N
- XX: Contact Plating
  - G1:Gold Flash
  - G3:2U" Gold
  - G4:3U" Gold
  - G4:5U" Gold
  - G6:10U" Gold
  - G7:15U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- S O
- X 0X: Packing
  - A=Tray
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.05.18	NEW DRAWING	

DIM	TOL
X.X	± 0.30
X.XX	± 0.20
X.XXX	± 0.10
Angle	± 3°

OPERATION | DRAW: Liu Miao 21.05.18 | CHECK | APPROVE

SCALE: FIT | UNIT: mm | SIZE: A4 | SHEET: 1/1 | PROJ.:

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	228502XXXNXXS0X0X
TITLE:	2.54PF H8.5mm 2xNpin 180° 0型